CYPR-CD00199 Patent

AMENDMENT TO SPECIFICATION

Please replace the sentence beginning at page 6, line 16 with the following

replacement sentence:

-- Die 10 includes a plurality of wirebonding pads 14 (which are typically used for

providing a wirebond or soldered electrical connection to the integrated circuit 18--

CYPR-CD00199 Examiner: Mason, D. Serial No.: 09/893,050 Group Art Unit: 2111